

EMI Filter & ESD Protection for Up Stream USB Ports

PRODUCTION DATA SHEET

DESCRIPTION

The LX7202 is an integrated upstream port. appropriate data line for full speed or appliances. low speed operation.

The 47 pF capacitor completes the Universal Serial Bus (USB) line high frequency filter and controls the termination device with an EMI filter edge rate of the USB signals. The and ESD protection diodes. This LX7202 protects both D+ and D- data device offers a cost effective and lines and the voltage bus from ESD. The compact solution for one USB TVS protection diodes exceed the The USB v1.1 requirements of IEC61000-4-2, level 4, specification requires line termination 15kV (air discharge) and 8kV (contact resistors on both the D+ and D- lines. discharge). The integrated configuration These resistors ensure signal integrity of the LX7202 minimizes board space by matching the cable impedance to and allows for ideal placement near the that of the differential driver. The 1.5 connector. The LX7202 is ideal for use $k\Omega$ pull-up resistor identifies the in USB hubs, peripherals and portable

IMPORTANT: For the most current data, consult MICROSEM's website: http://www.microsemi.com

PACKAGE ORDER INFO					
$T_{J}\left(^{o}C\right)$	SF Plastic 6-Pin SOT23	Package Marking	Tape & Reel Quantity (Reel Size)		
-40 to 125	LX7202-15ISF	215	3K (7inches)		
-40 to 125	LX7202-22ISF	222			

Note: Append the letter "T" to the part number For Tape & Reel Ordering

KEY FEATURES

- Bi-directional EMI/RFI low-pass filter
- Line termination with integrated ESD protection
- Low TVS operating voltage (5.25V)
- Low leakage current
- Integrated single die construction
- Available with 15 or 22Ω Series Resistance
- Crosses from Semtech STF202

APPLICATIONS

- USB Ports .
- Peripherals
- **Computers and Printers**
- . Mobile phones
- Pagers and PDA's
- **Digital Cameras**

BENEFITS

- Filter response characterized up to 6 GHz
- <2dB insertion loss in the pass hand
- >20dB attenuation in the 800-900 MHz range
- >12dB attenuation in the WLAN frequencies of 2.4GHz and 5.0-6.0 GHz

6

5

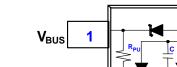
4

GND

DOUT

DOUT

toIC



2

3

Functional Schematic with PinOut

DIN

from connector

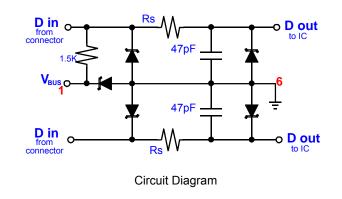
DIN

from

connector



PRODUCT HIGHLIGHT



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6 GND

5

4

DOUT

to IC

 $\mathsf{D}_{\mathsf{OUT}}$

to IC

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V_{BUS}

D_{IN} from

D_{IN} 3 from

connector

connector

2

PACKAGE PIN OUT

SF PACKAGE

(Top View)

1

ABSOLUTE MAXIMUM RATINGS

Steady State Power	100mW
ESD Air Discharge per IEC61000-4-2	
ESD Contact Discharge per IEC61000-4-2	10KV
Lead Soldering Temperature (10 Seconds)	
Operating Temperature	40°C to +125°C
Storage Temperature Range	55°C to +150°C

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

THERMAL DATA

SF Plastic SOT-23 6-Pin

THERMAL RESISTANCE-JUNCTION TO CASE, θ_{JC}	62 °C/W
THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}	96 °C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.

The θ_{IA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

FUNCTIONAL PIN DESCRIPTION				
Name	Description			
VBUS	Bus Voltage			
DIN	Data In			
GND	Ground			
DOUT	Data Out			

ELECTRICAL CHARACTERISTICS

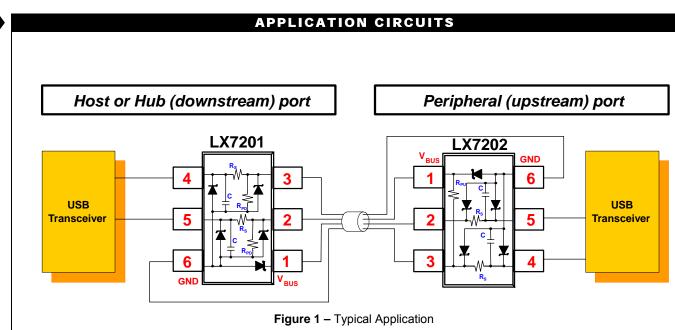
Unless otherwise specified, the following specifications apply over the operating ambient temperature -40°C $\leq T_A \leq +125$ °C except where otherwise noted.

Parameter	Symbol	Test Conditions		LX7202-xx		
Falameter	Symbol			Тур	Max	Units
Stand-Off Voltage	VR _{WM}				5.25	V
Breakdown Voltage	V _{BR}	IR = 1mA	6			V
Leakage Current	I _R	VRWM = 5.25V, T = 25°C			1	μA
Series Resistance (-15)	Rs	Each Line	13.5	15	16.5	Ω
Series Resistance (-22)	Rs	Each Line	19.8	22	24.2	Ω
Temperature Coefficient of R _S	T _{COEFF}	Each Line		200		ppm
Pull Up Resistance	R _{PU}	Each Line	1.35	1.5	1.65	KΩ
Capacitor	С	Each Line		47		pF
Total Capacitance	Стот	Between I/O Pins and Ground, Each Device VR = 0V, f = 1MHz	54	60	66	pF



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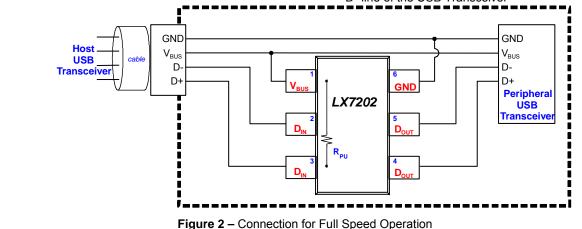
APPLICATION INFORMATION

The LX7202 meets the requirements of the USB v1.1 specification for device termination, EMI filtering and ESD protection. The RS resistor provides the proper signal termination; the 47pF capacitor controls the signal rise and fall slew; the TVS diodes protect the IC from ESD damage; and the total capacitance and resistance creates a low pass filter eliminating the high frequency energy from the circuit. The LX7202 can configure the upstream port for either Full-Speed or Low-Speed operation. The figures below show the proper connection in accordance with the USB v1.1 specification.

FULL SPEED DEVICE

The USB specification offers a 12 Mbps data transfer rate known as Full-Speed which requires a 1.5 k Ω pull-up resistor to be connected to the D+ line. Slew rate control is accomplished with 47pF attached to the transceiver before the R_S.

- Voltage Supply (Vbus) is connected to Pin 1
- Ground is connected to Pin 6
- D+ from the connector is routed to Pin 3 (1.5 kΩ pull-up resistor) and Pin 4 to the D+ line of the USB Transceiver
- D- from the connector is routed to Pin 2 and Pin 5 to the D- line of the USB Transceiver





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APPLICATION INFORMATION (CONTINUED)

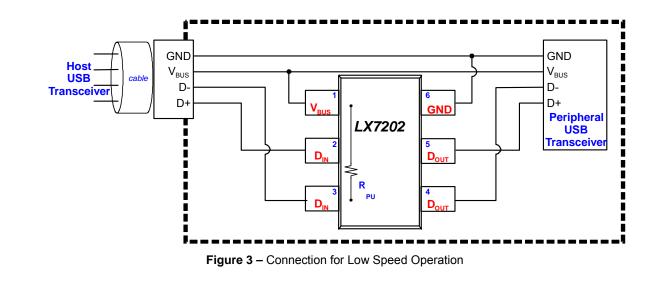
LOW SPEED DEVICE

The USB specification offers a 1.5 Mbps data transfer rate known as Low-Speed which requires a 1.5 k Ω pull-up resistor to be connected to the D- line. Slew rate control is accomplished with 47pF attached to the transceiver before the R_s.

- Voltage Supply (Vbus) is connected to Pin 1
- Ground is connected to Pin 6

• D+ from the connector is routed to Pin 2 and Pin 5 to the D+ line of the USB Transceiver

• D- from the connector is routed to Pin 3 (1.5 k Ω pullup resistor) and Pin 4 to the D- line of the USB Transceiver



ELECTROMAGNETIC EMISSION AND SUSCEPTABILITY

FCC Part 15 sets limits for maximum allowable EM emission and susceptibility. There are two types of emissions. Conducted emissions with frequency of emission of 0.45 to 30 MHz and Radiated emissions with frequency of emission of 30 MHz to 40 GHz. All digital computing devices including the peripheral devices must comply. Examples of peripheral devices include terminals, printers, external floppy disk drives and other fixed adjustable data storage devices, video monitors, keyboards,

control cards, interface boards, external memory expansion cards and other input/output devices that may or may not contain digital circuitry. LX7202 is optimized to minimize the radiated EMI which is the primary concern in devices using USB. Refer to the typical filter response curve for the attenuation characteristics of LX7202 over the frequency range of 30KHz to 6GHz.



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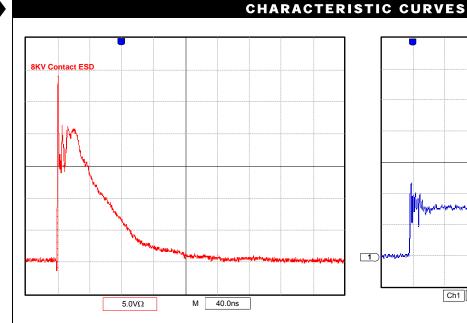


Figure 4 – 8KV ESD input pulse as per IEC61000-4-2. Vertical scale is equivalent to 5A/div.

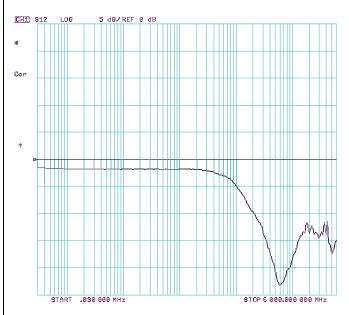


Figure 6 – Frequency response curve. Low insertion loss in the pass band and -20dB attenuation at 800-900 MHz. Better than -10dB attenuation at the WLAN frequencies of 2.4 and 5.0-6.0 GHz.

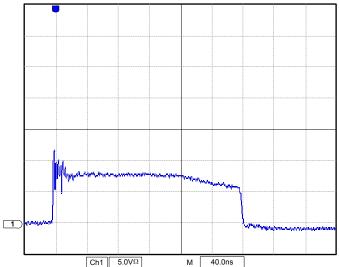


Figure 5 – Clamping Characteristics when device subjected to an 8 KV ESD pulse.

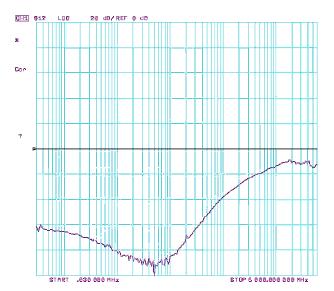


Figure 7 – Analog Crosstalk between the two datalines D- and D+



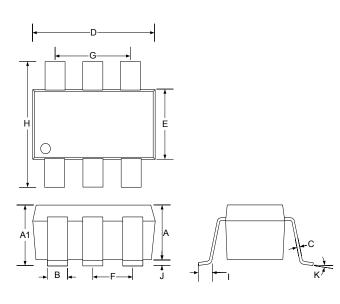
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PACKAGE DIMENSIONS

SF

6 Pin Plastic SOT-23

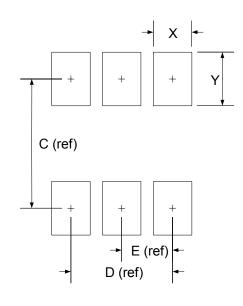


	MILLIMETERS		INCHES			
Dim	MIN	MAX	MIN	MAX		
Α	0.90	1.30	0.035	0.051		
A1	0.90	1.45	0.035	0.057		
В	0.25	0.50	0.010	0.020		
С	0.09	0.20	0.004	0.008		
D	2.80	3.10	0.110	0.122		
E	1.50	1.75	0.059	0.069		
F	0.95	0.95 BSC 1.90 BSC		0.038 BSC		
G	1.90			075 BSC		
Н	2.60	3.00	0.102	0.118		
I	0.35	0.55	0.014	0.022		
J	0.00	0.15	0.000	0.006		
K	10° MAX		10°	MAX		

Note:

1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.155mm(.006") on any side. Lead dimension shall not include solder coverage.

Recommended Footprint



	MILLIMETERS		INCHES		
Dim	MIN	MAX	MIN	MAX	
С	-	2.40	-	0.094	
D	-	1.90	-	0.074	
E	-	0.95	-	0.037	
Х	-	0.70	-	0.028	
Y	-	1.00	-	0.039	

MECHANICALS

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NOTES

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